

45V $I_o=200\text{mA}$ Ultra low Quiescent current LDO

■FEATURES

- Low Quiescent Current $5.5\mu\text{A typ. (A version)}$
 $5.0\mu\text{A typ. (B version)}$
- Operating Voltage $4.0\text{V to }40\text{V}$
- Operating Temperature $T_a=-40^\circ\text{C to }125^\circ\text{C}$
- Output Voltage Accuracy $V_o \pm 1.0\% (T_a=25^\circ\text{C})$
 $V_o \pm 2.0\% (T_a=-40^\circ\text{C to }125^\circ\text{C})$
- Output Current $I_o(\text{min.})=200\text{mA}$
- ON/OFF Control A ver. only
- Correspond to MLCC
- Under Voltage Lock Out circuit
- Thermal Shutdown Circuit
- Over Current Protection Circuit
- Package Outline A ver. SOT-89-5-2
 B ver. SOT-89-3, TO-252-3-L1

■GENERAL DESCRIPTION

NJW4104 is a 45V $I_o=200\text{mA}$ ultra low quiescent current low dropout regulator.

It achieves low quiescent current characteristics, therefore it contributes to reduce current consumption of applications.

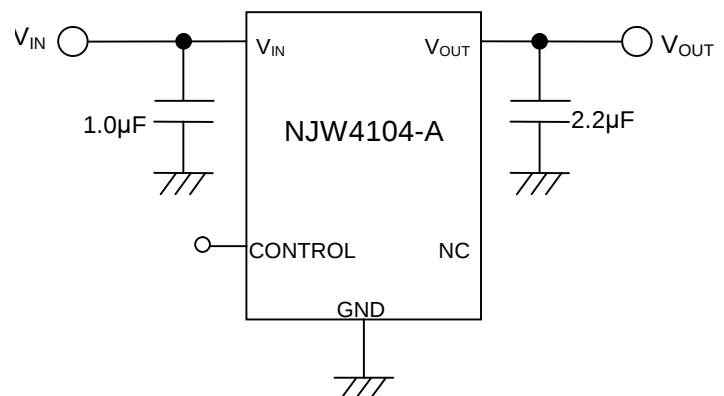
Output Voltage is guaranteed $\pm 2\%$ under wide range conditions: $V_{IN}=V_o+1\text{V to }40\text{V}$, $I_o=0$ to 200mA and $T_a=-40^\circ\text{C to }125^\circ\text{C}$.

Because of wide input voltage range and wide operating temperature range, the NJW4104 is suitable for various applications including automotive applications.

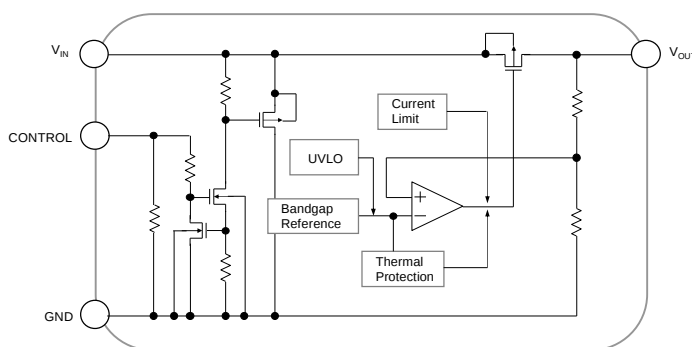
■APPLICATION

- Automotive infotainment
- Automotive ECU unit
- Industrial equipment

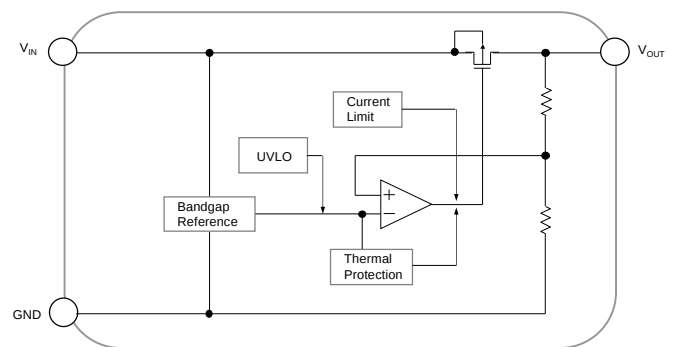
■TYPICAL APPLICATION



■BLOCK DIAGRAM



A version



B version

■OUTPUT VOLTAGE RANK

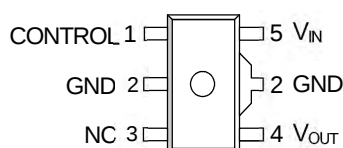
SOT-89-5-2

SOT-89-3

TO-252-3-L1

PART NUMBER	OUTPUT VOLTAGE	PART NUMBER	OUTPUT VOLTAGE	PART NUMBER	OUTPUT VOLTAGE
NJW4104U2-33A / -T1	3.3V	NJW4104U3-33B / -T1	3.3V	NJW4104DL1-33B	3.3V
NJW4104U2-05A / -T1	5.0V	NJW4104U3-05B / -T1	5.0V	NJW4104DL1-05B	5.0V

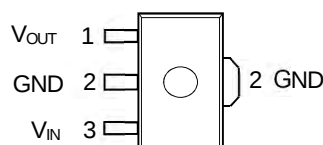
■PIN CONFIGURATION



SOT-89-5-2

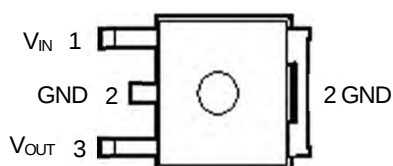
PIN NO.	SYMBOL	DESCRIPTION
1	CONTROL	ON/OFF Control
2	GND	Ground
3	NC	No Connection*
4	V_{OUT}	Output
5	V_{IN}	Input

*Note) NC pin is not connect to internally circuit. This pin can be open or connected to ground. Connecting to ground is recommended to improve thermal dissipation.



SOT-89-3

PIN NO.	SYMBOL	DESCRIPTION
1	V_{OUT}	Output
2	GND	Ground
3	V_{IN}	Input



TO-252-3-L1

PIN NO.	SYMBOL	DESCRIPTION
1	V_{IN}	Input
2	GND	Ground
3	V_{OUT}	Output

■PRODUCT NAME INFORMATION

	NJW4104	U2	-	05	A	-	T1	(TE1)	
Device Name	Package	Output Voltage	Version	Spec	Taping form				
	U2: SOT-89-5-2	33: 3.3V	A: ON/OFF	T1: Automotive					
	U3: SOT-89-3	05: 5.0V	B: without ON/OFF						
	DL1: TO-252-3-L1								

■ORDERING INFORMATION

PRODUCT NAME	OUTPUT VOLTAGE	PACKAGE OUTLINE	AUTOMOTIVE SPEC	RoHS	HALOGEN-FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ (pcs)
NJW4104U2-33A(Te1)	3.3V	SOT-89-5-2		yes	yes	Sn-2Bi	231	61	1000
NJW4104U2-05A(Te1)	5.0V	SOT-89-5-2		yes	yes	Sn-2Bi	241	61	1000
NJW4104U2-33A-T1(Te1)	3.3V	SOT-89-5-2	yes	yes	yes	Sn-2Bi	251	61	1000
NJW4104U2-05A-T1(Te1)	5.0V	SOT-89-5-2	yes	yes	yes	Sn-2Bi	261	61	1000
NJW4104U3-33B(Te1)	3.3V	SOT-89-3		yes	yes	Sn-2Bi	001	61	1000
NJW4104U3-05B(Te1)	5.0V	SOT-89-3		yes	yes	Sn-2Bi	011	61	1000
NJW4104U3-33B-T1(Te1)	3.3V	SOT-89-3	yes	yes	yes	Sn-2Bi	021	61	1000
NJW4104U3-05B-T1(Te1)	5.0V	SOT-89-3	yes	yes	yes	Sn-2Bi	031	61	1000
NJW4104DL1-33B(Te1)	3.3V	TO-252-3-L1		yes	yes	Sn-2Bi	04B33	301	3000
NJW4104DL1-05B(Te1)	5.0V	TO-252-3-L1		yes	yes	Sn-2Bi	04B05	301	3000

Note) "-" is non-evaluation. Please contact your sales representative for more information.

■ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATINGS	UNIT
Input Voltage	V_{IN}	-0.3 to +45	V
Control Pin Voltage ⁽¹⁾	V_{CONT}	-0.3 to +45	V
Output Voltage	V_{OUT}	-0.3 to $V_{IN} \leq +17$	V
Power Dissipation($T_a=25^\circ\text{C}$)	P_D	(2-layer / 4-layer)	mW
SOT-89		625 ⁽²⁾ / 2400 ⁽³⁾	
TO-252		1190 ⁽²⁾ / 3125 ⁽³⁾	
Junction Temperature Range	T_j	-40 to +150	$^\circ\text{C}$
Operating Temperature Range	T_{opr}	-40 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-50 to +150	$^\circ\text{C}$

(1): Applied for A version.

(2): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JEDEC standard, 2Layers)

(3): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JEDEC standard, 4Layers), internal Cu area: 74.2x74.2mm

(For 4Layers :Applying 74.2 x 74.2mm inner Cu area and thermal via holes to board based on JEDEC standard JESD51-5)

■RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Operating Voltage Range	V_{IN}	4.0 to 40	V
Control Voltage	V_{CONT}	0 to 40	V

■ELECTRICAL CHARACTERISTICS

 Unless other noted, $V_{IN} = V_O + 1V$, $C_{IN} = 1.0\mu F$, $C_O = 2.2\mu F$, $T_a = 25^\circ C$

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	単位
Output Voltage	V_O	$V_{IN} = V_O + 1V$ to 40V, $I_O = 0mA$ to 200mA,	-1.0%	-	+1.0%	V
		$V_{IN} = V_O + 1V$ to 40V, $I_O = 0mA$ to 200mA, $T_a = -40^\circ C$ to $+125^\circ C$	-2.0%	-	+2.0%	
Quiescent Current	I_Q	A version, $I_O = 0mA$, except I_{CONT}	-	5.5	9.5	μA
		A version, $I_O = 0mA$, except I_{CONT} , $T_a = -40^\circ C$ to $+125^\circ C$	-	-	13.5	
		B version, $I_O = 0mA$	-	5.0	8.5	
		B version, $I_O = 0mA$, $T_a = -40^\circ C$ to $+125^\circ C$	-	-	12	
Quiescent Current at Control OFF ⁽⁴⁾	$I_{Q(OFF)}$	$V_{CONT} = 0V$	-	-	1	μA
		$V_{CONT} = 0V$, $T_a = -40^\circ C$ to $+125^\circ C$	-	-	1	
Output Current	I_O	$V_O \times 0.9$	200	-	-	mA
		$V_O \times 0.9$, $T_a = -40^\circ C$ to $+125^\circ C$	200	-	-	
Line Regulation	$\Delta V_O / \Delta V_{IN}$	$V_{IN} = V_O + 1V$ to 40V, $I_O = 30mA$	$V_O = 3.3V$	-	-	mV
			$V_O = 5.0V$	-	-	
		$V_{IN} = V_O + 1V$ to 40V, $I_O = 30mA$, $T_a = -40^\circ C$ to $+125^\circ C$	$V_O = 3.3V$	-	-	
			$V_O = 5.0V$	-	-	
Load Regulation	$\Delta V_O / \Delta I_O$	$I_O = 0mA$ to 200mA	$V_O = 3.3V$	-	-	mV
			$V_O = 5.0V$	-	-	
		$I_O = 0mA$ to 200mA, $T_a = -40^\circ C$ to $+125^\circ C$	$V_O = 3.3V$	-	-	
			$V_O = 5.0V$	-	-	
Ripple Rejection	RR	$V_{IN} = 7.0V$, $r_{in} = 200mV_{rms}$, $f = 1kHz$, $I_O = 10mA$	$V_O = 3.3V$	-	41	dB
			$V_O = 5.0V$	-	36	
Dropout Voltage ⁽⁵⁾	ΔV_{IO}	$I_O = 100mA$	-	0.18	0.25	V
		$I_O = 100mA$, $T_a = -40^\circ C$ to $+125^\circ C$	-	-	0.46	
Control Current ⁽⁴⁾	I_{CONT}	$V_{CONT} = 1.6V$	-	0.5	2	μA
		$V_{CONT} = 1.8V$, $T_a = -40^\circ C$ to $+125^\circ C$	-	-	3	
Control Voltage for ON-state ⁽⁴⁾	$V_{CONT(ON)}$		1.6	-	-	V
		$T_a = -40^\circ C$ to $+125^\circ C$	1.8	-	-	
Control Voltage for OFF-state ⁽⁴⁾	$V_{CONT(OFF)}$		-	-	0.6	V
		$T_a = -40^\circ C$ to $+125^\circ C$	-	-	0.6	
UVLO Release Voltage	V_{UVLO}	$V_{IN} = L \rightarrow H$	2.4	2.8	3.3	V
		$V_{IN} = L \rightarrow H$, $T_a = -40^\circ C$ to $+125^\circ C$	2.1	-	3.5	
UVLO Hysteresis Voltage	V_{HYS}	$V_{IN} = H \rightarrow L$	70	200	-	mV
		$V_{IN} = H \rightarrow L$, $T_a = -40^\circ C$ to $+125^\circ C$	70	-	-	
Average Temperature Coefficient of Output Voltage	$\Delta V_O / \Delta T_a$	$T_a = -40^\circ C$ to $125^\circ C$, $I_O = 30mA$	-	± 50	-	ppm/ $^\circ C$

(4): Applied for A version.

(5): Except Output Voltage Rank less than 3.8V

 Characteristics values of defined as $T_a = -40^\circ C$ to $+125^\circ C$ are applied only "T1" spec.

■THERMAL CHARACTERISTICS

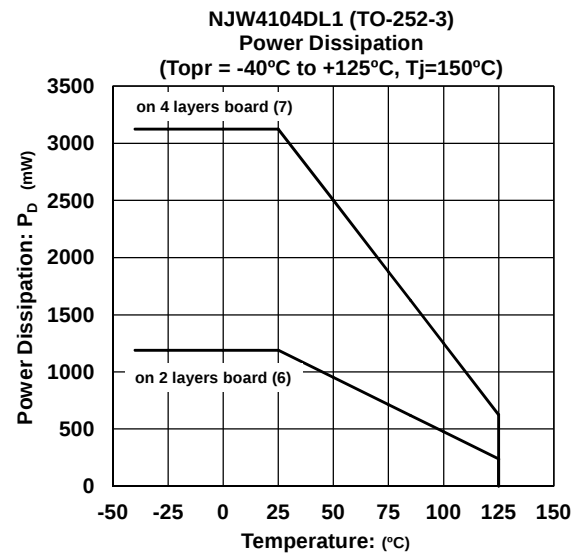
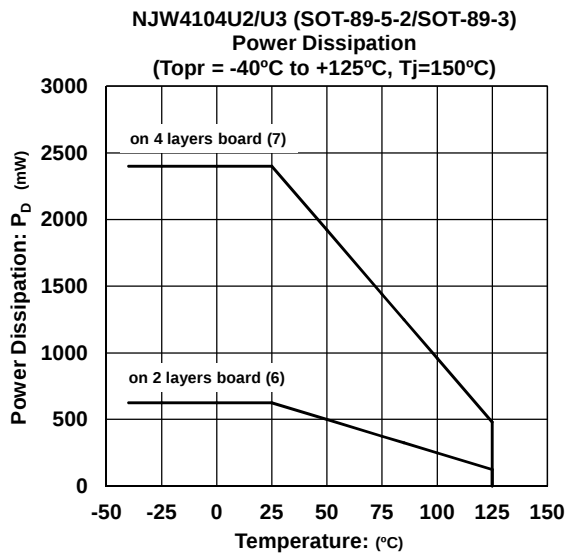
PARAMETER	SYMBOL	VALUE		UNIT
Junction-to-ambient thermal resistance	θ_{ja}	SOT-89-3/-5-2	200 ⁽⁶⁾ 52 ⁽⁷⁾	°CW
		TO-252-3-L1	105 ⁽⁶⁾ 40 ⁽⁷⁾	
Junction-to-Top of package characterization parameter	ψ_{jt}	SOT-89-3/-5-2	43 ⁽⁶⁾ 19 ⁽⁷⁾	°CW
		TO-252-3-L1	17 ⁽⁶⁾ 12 ⁽⁷⁾	

(6): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JEDEC standard, 2Layers)

(7): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JEDEC standard, 4Layers), internal Cu area: 74.2x74.2mm

(For 4Layers :Applying 74.2 x 74.2mm inner Cu area and thermal via holes to board based on JEDEC standard JESD51-5)

■POWER DISSIPATION vs. AMBIENT TEMPERATURE



*Input Capacitor C_{IN}

The input capacitor C_{IN} is required in order to prevent oscillation and reduce power supply ripple of applications when high power supply impedance or a long power supply line.

Therefore, the recommended capacitance (refer to conditions of ELECTRIC CHARACTERISTIC) or larger input capacitor, connected between V_{IN} and GND as short path as possible, is recommended in order to avoid the problem.

*Output Capacitor C_O

The output capacitor C_O is required for a phase compensation of the internal error amplifier, and the capacitance and the equivalent series resistance (ESR) influence stable operation of the regulator.

If use a smaller output capacitor than the recommended capacitance (refer to conditions of ELECTRIC CHARACTERISTIC), it may cause excess output noise or oscillation of the regulator due to lack of the phase compensation. Therefore, the recommended capacitance or larger output capacitor, connected between V_{OUT} and GND as short path as possible, is recommended for stable operation. The recommended capacitance may be different by output voltage, therefore confirm the recommended capacitance of the required output voltage.

Furthermore, a larger output capacitor reduces output noise and ripple output, and also improves Output Transient Response when a load changes rapidly.

Selecting the output capacitor, should consider varied characteristics of a capacitor: frequency characteristics, temperature characteristics, DC bias characteristics and so on. Therefore, the capacitor that has a sufficient margin of the rated voltage against the output voltage and superior temperature characteristics, is recommended for C_O .

*Transient Response of Output Voltage

In general, the regulator tends to cause overshoot or undershoot of output voltage at the following conditions.

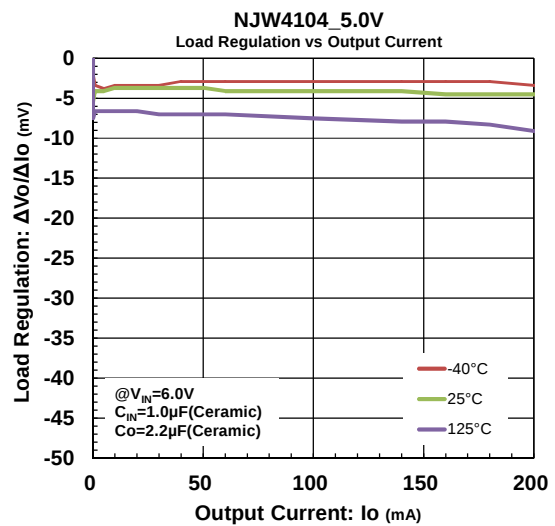
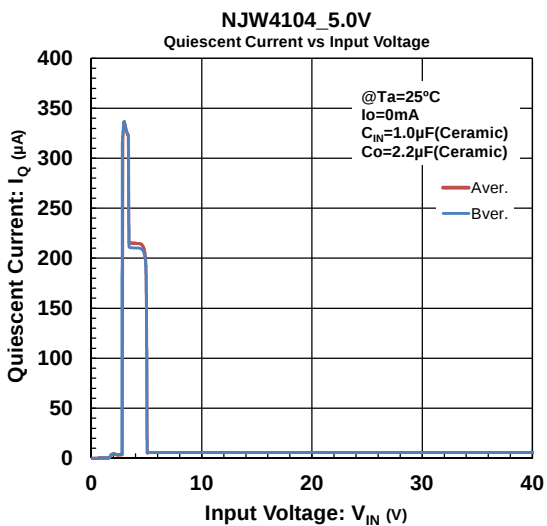
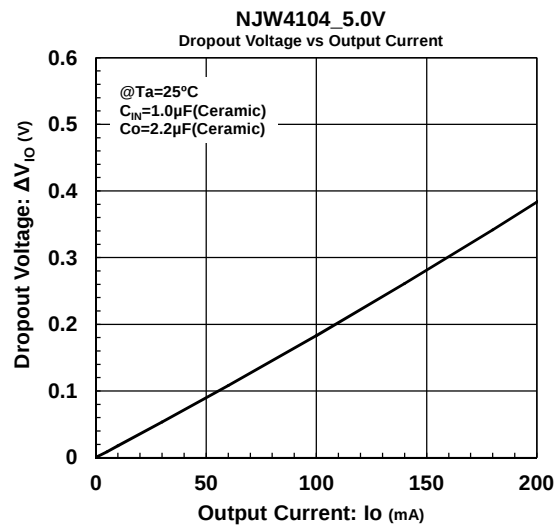
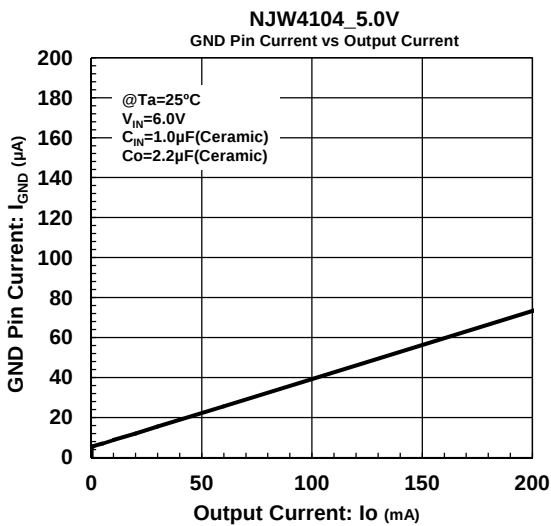
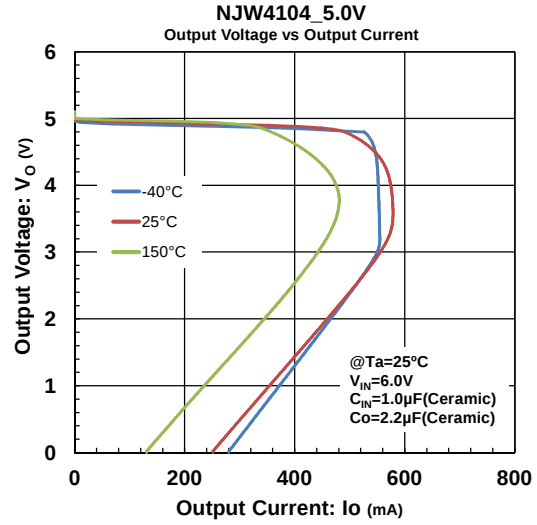
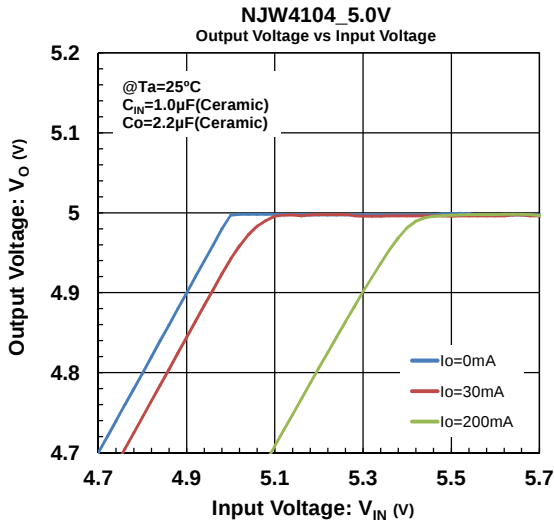
Particularly in products featuring low current consumption, the output voltage fluctuation may become large due to product characteristics.

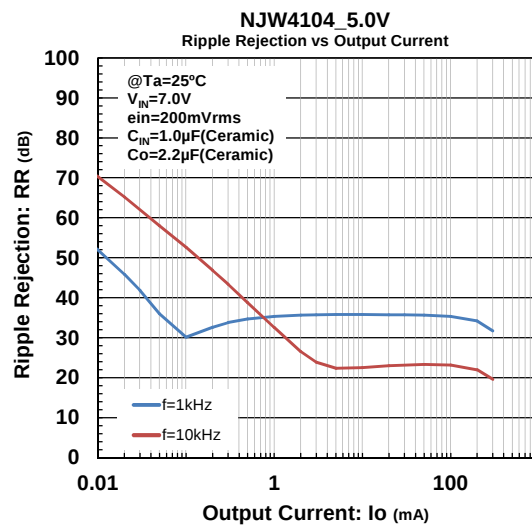
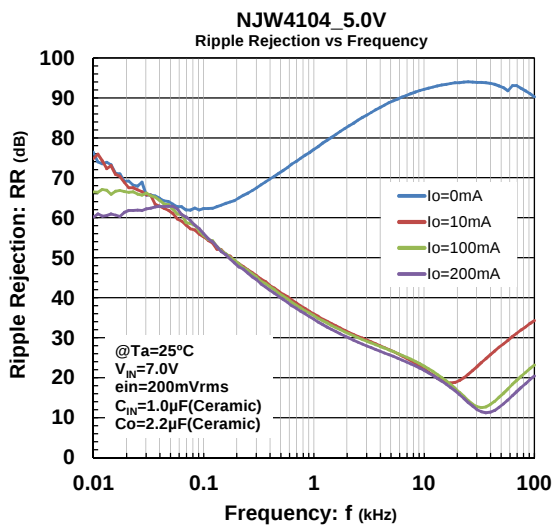
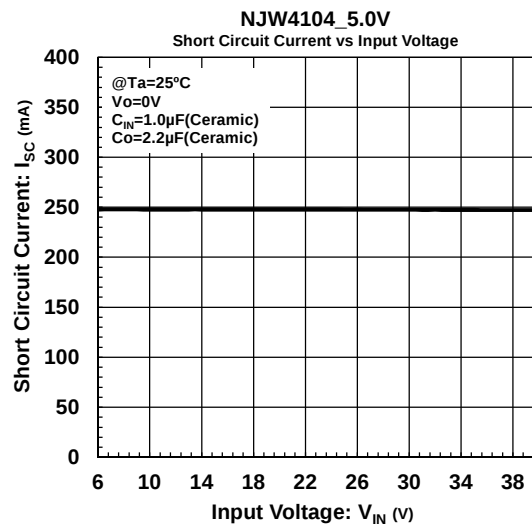
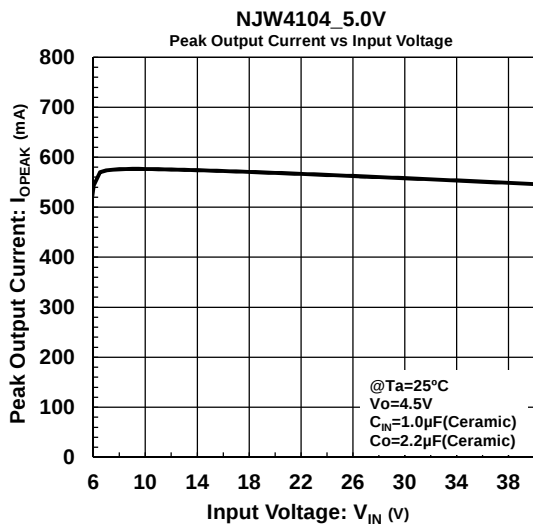
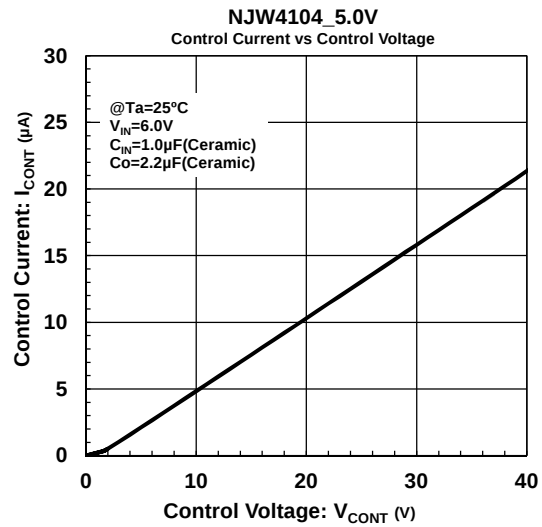
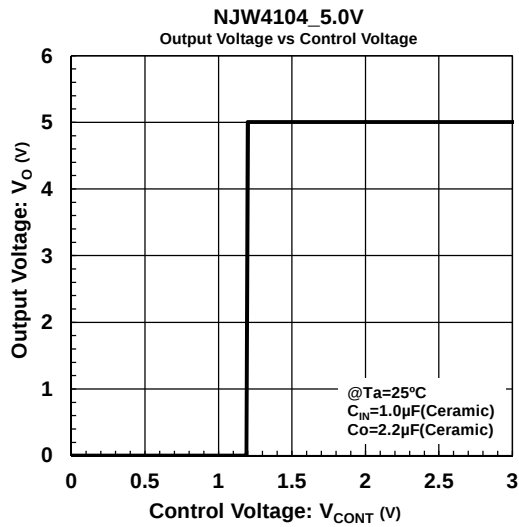
- When input voltage or output current fluctuate sharply
- When output capacitance is small
- When output load is light
- When start up from the condition of narrow voltage difference between an Input and an output.

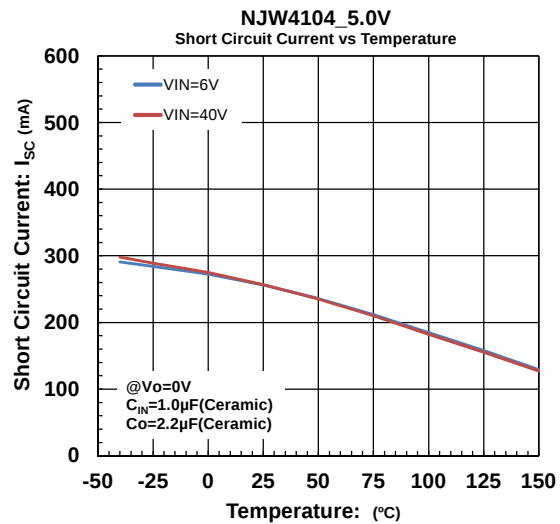
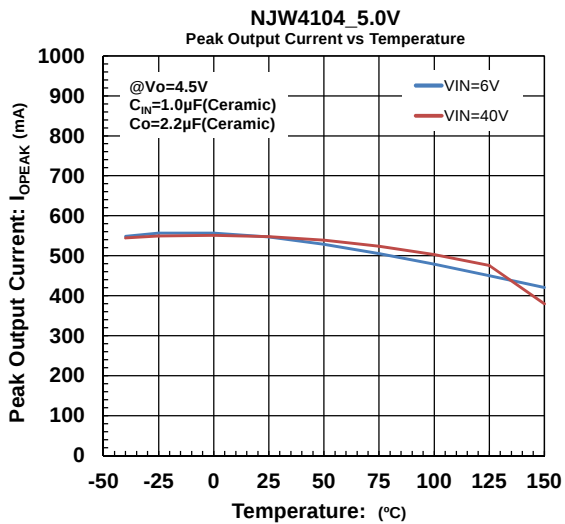
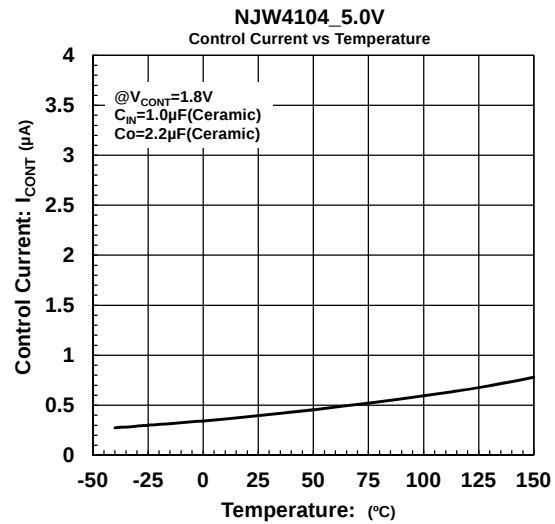
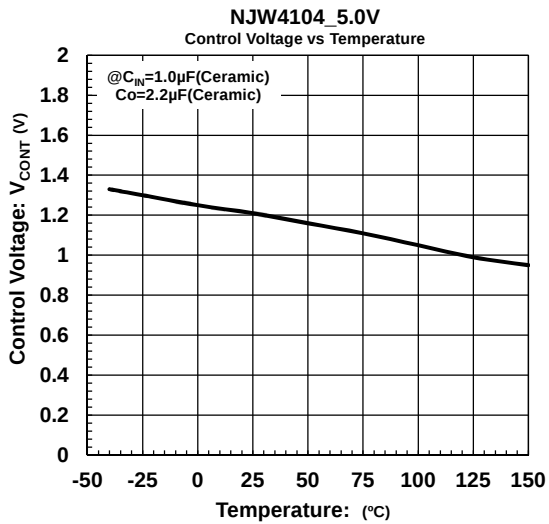
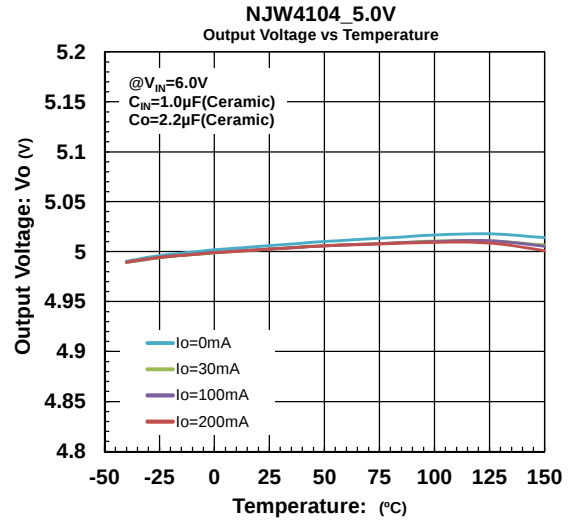
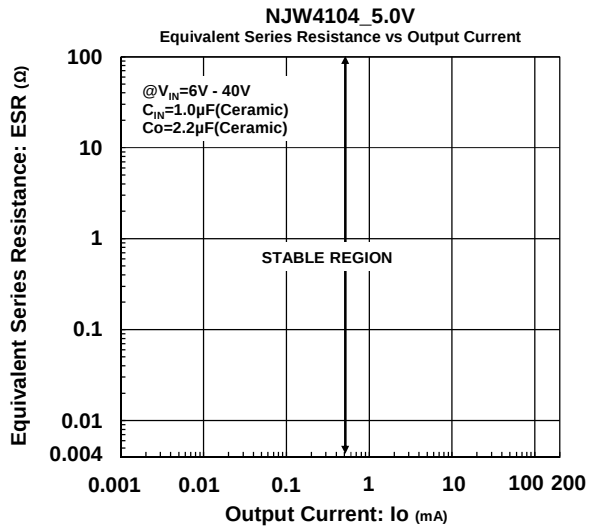
One way to improve transient response is to use a large capacity input and output capacitors to suppress to the fluctuation.

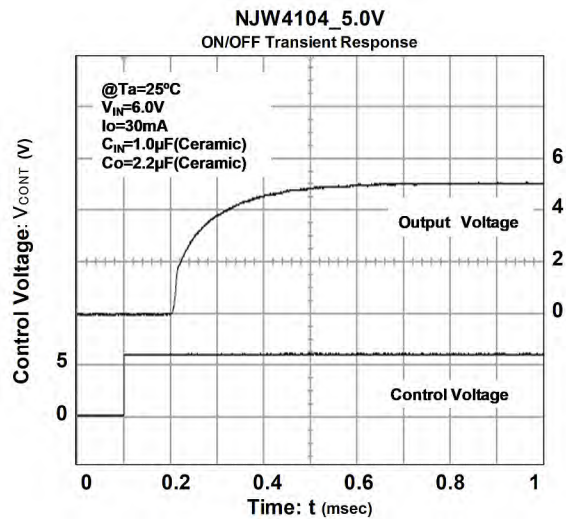
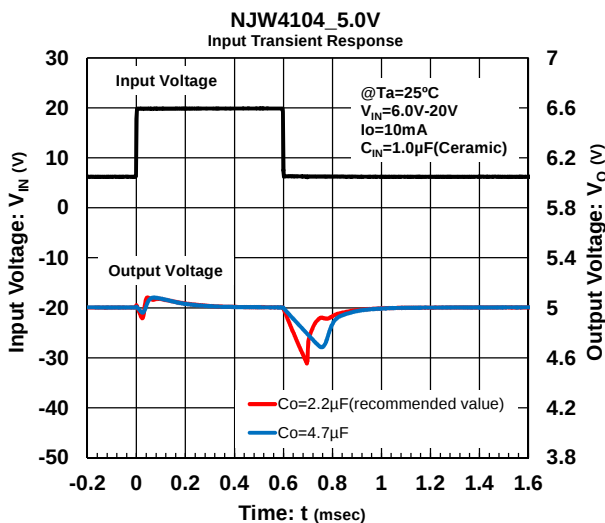
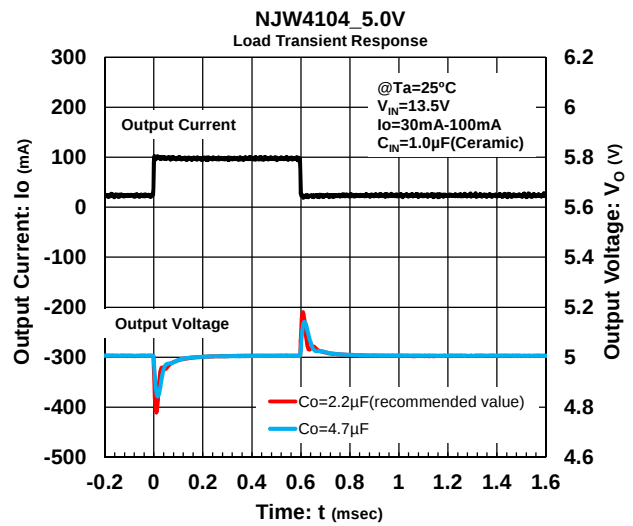
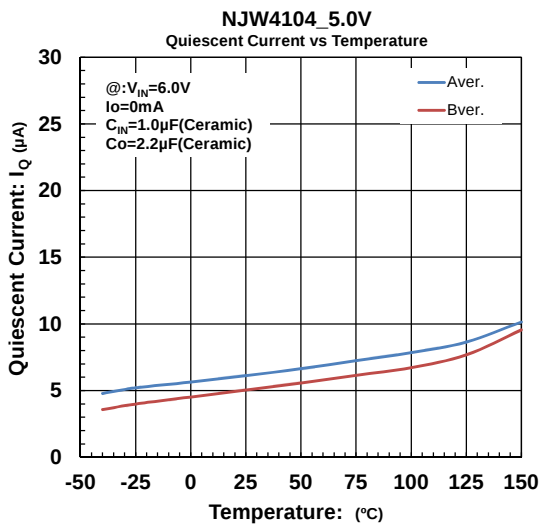
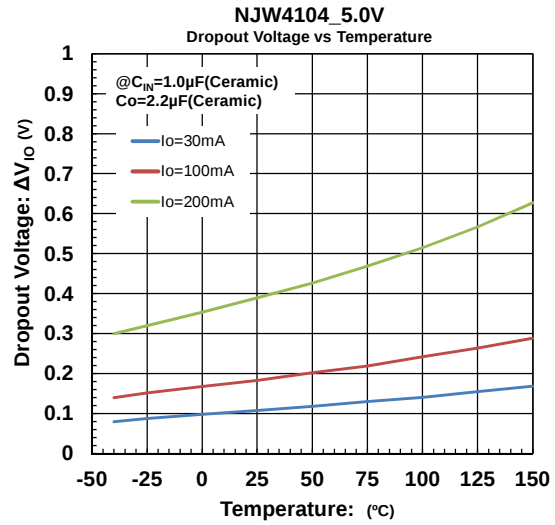
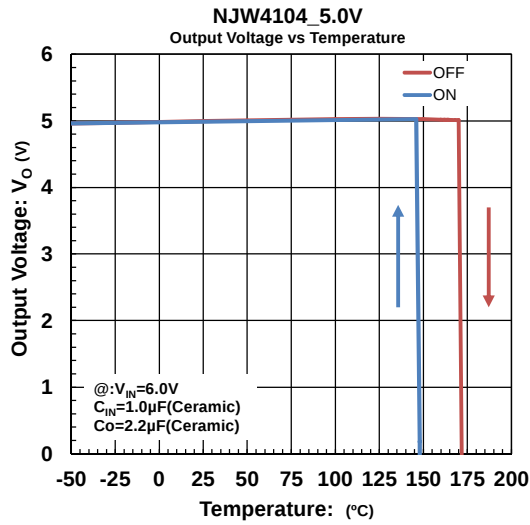
Amount of transient fluctuation will change according to multiple conditions, so please refer to the above to confirm with actual equipment.

■ TYPICAL CHARACTERISTICS





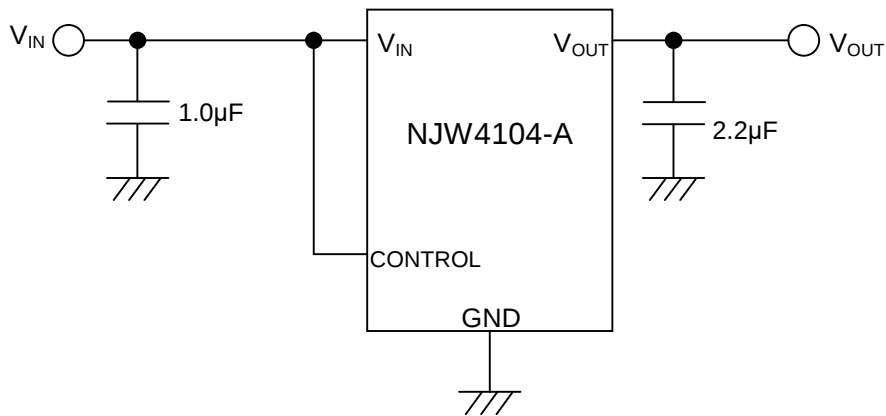




■TYPICAL APPLICATION

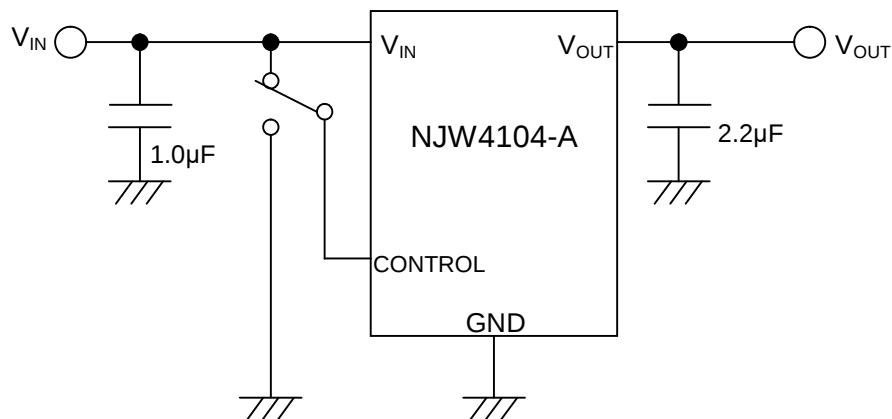
●A version

1. In the case where ON/OFF Control is not required



Connect CONTROL Pin to V_{IN} Pin

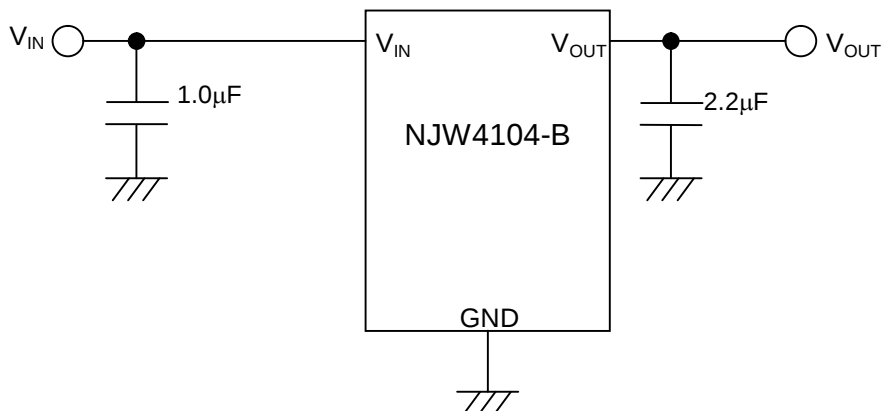
2. In use of ON/OFF CONTROL



State of CONTROL Pin:

"H" → output is enabled. "L" or "open" → output is disabled

●B version



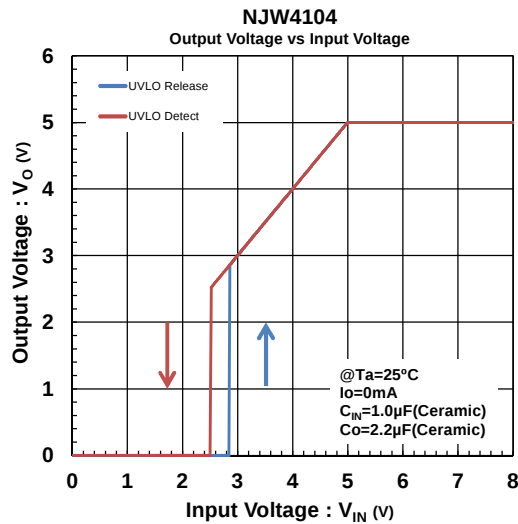
■APPLICATION NOTE / GLOSSARY

*Under Voltage Lockout UVLO

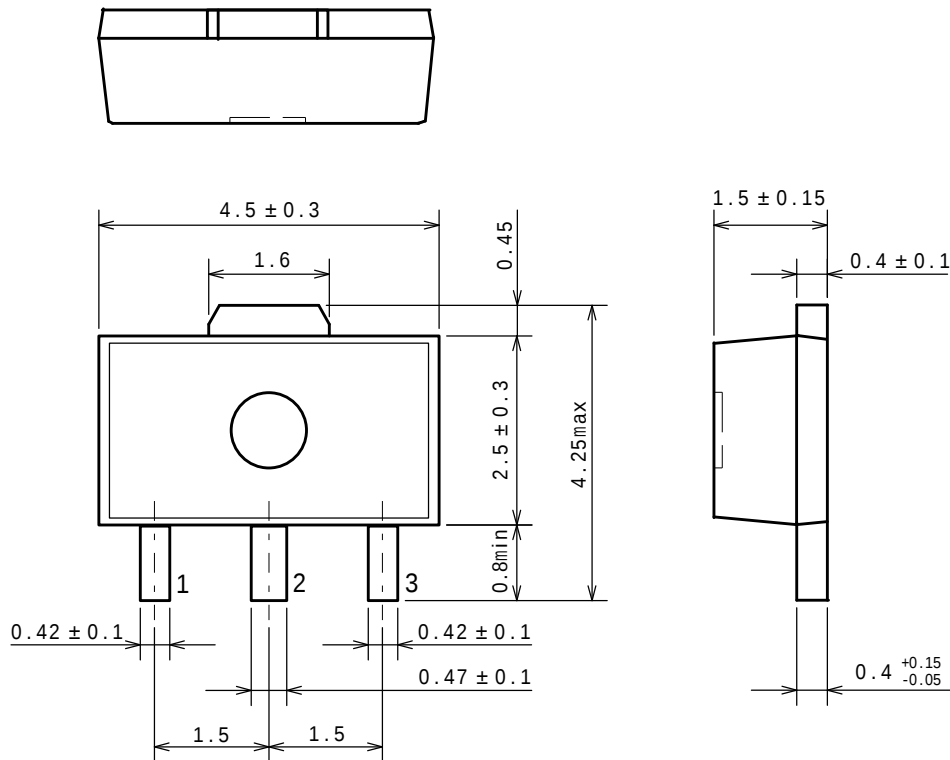
The NJW4104 includes UVLO circuit to prevent malfunction in case of low input voltage.

When the input voltage increases and exceeds the “UVLO Release voltage” (2.8V typ.), UVLO is released and the output voltage rises up.

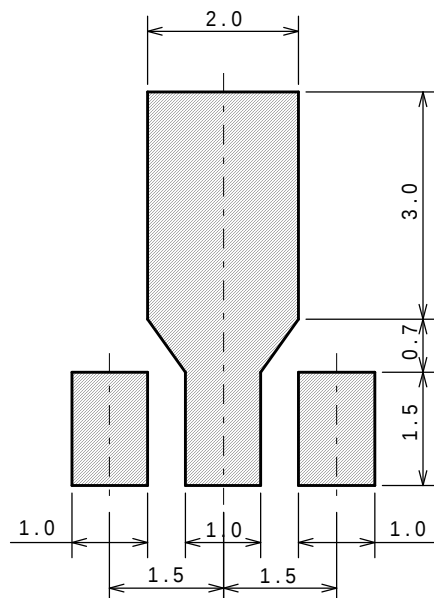
The UVLO circuit has hysteresis(200mV typ.). Therefore, if the input voltage decreases below the threshold voltage: “UVLO Release voltage” – “UVLO Hysteresis Voltage”, the output voltage shuts down.



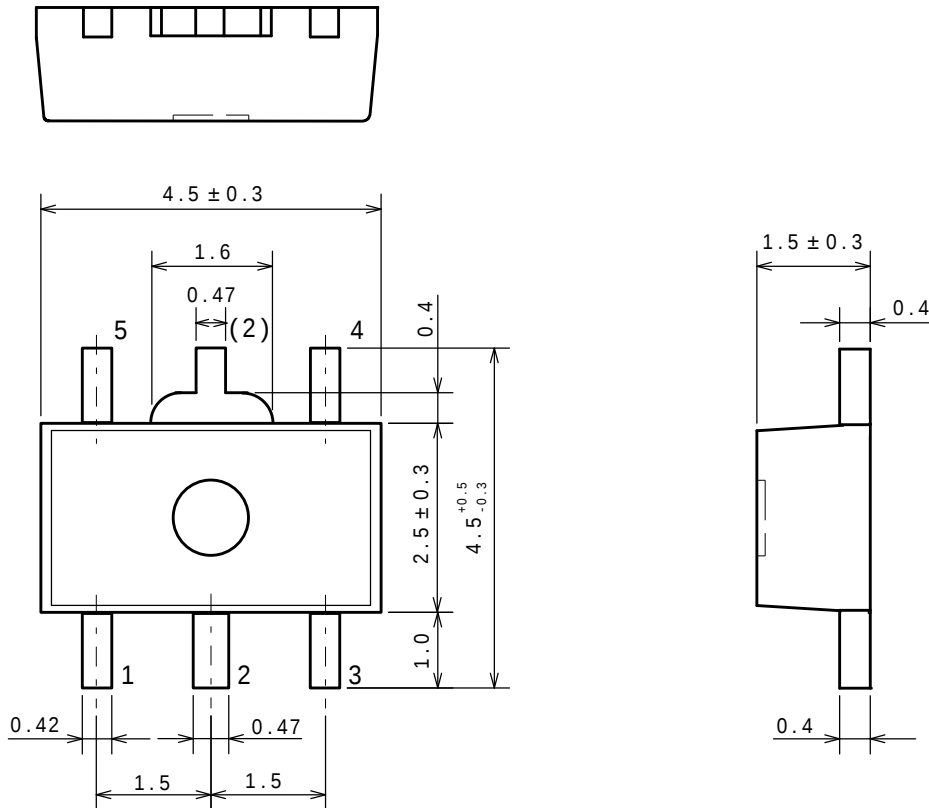
■ PACKAGE DIMENSIONS



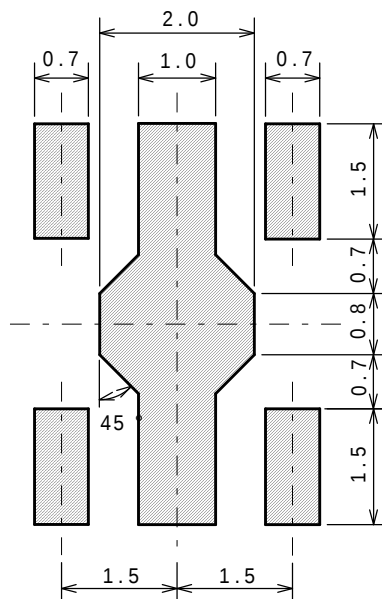
■EXAMPLE OF SOLDER PADS DIMENSIONS



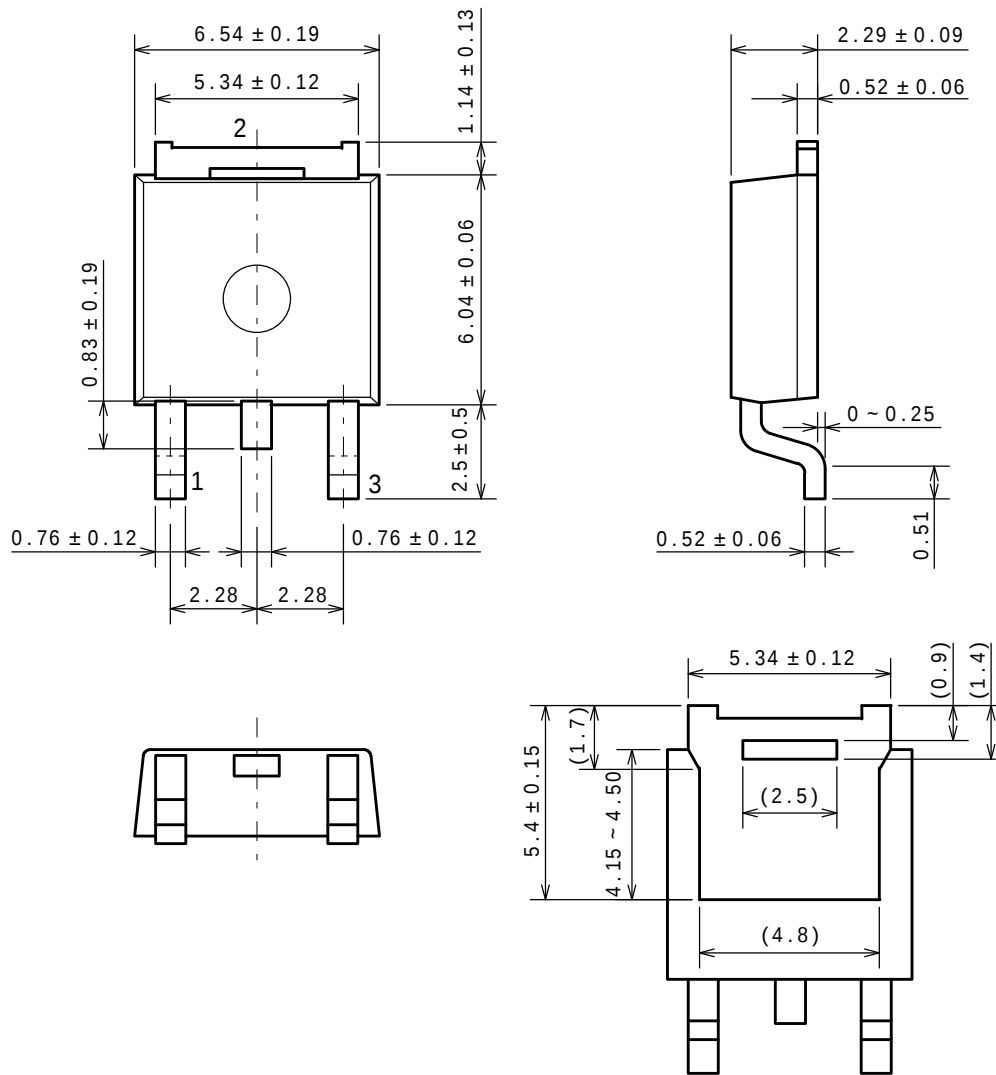
■PACKAGE DIMENSIONS



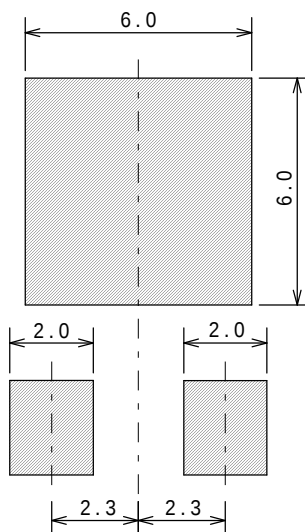
■EXAMPLE OF SOLDER PADS DIMENSIONS



■ PACKAGE DIMENSIONS

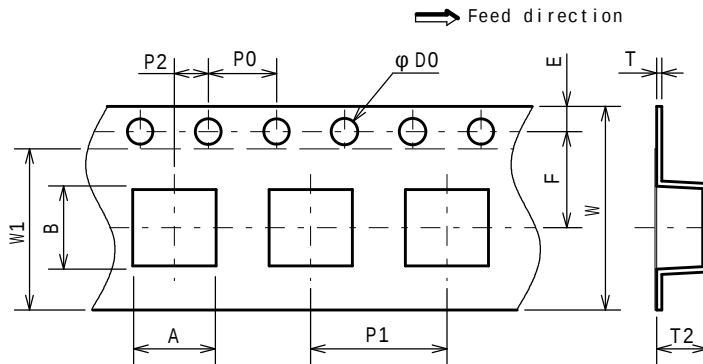


■ EXAMPLE OF SOLDER PADS DIMENSIONS



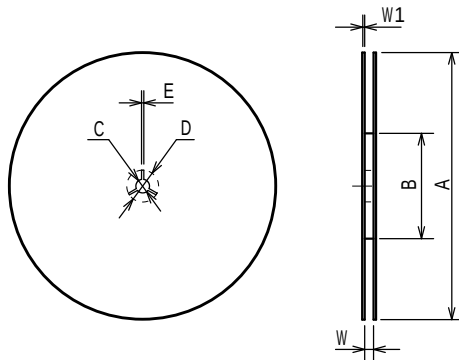
PACKING SPEC

TAPING DIMENSIONS



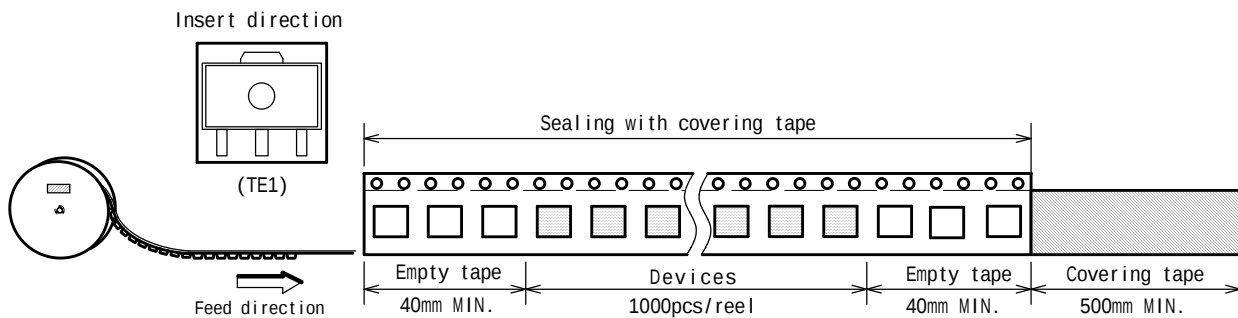
SYMBOL	DIMENSION	REMARKS
A	4.9 ± 0.1	BOTTOM DIMENSION
B	4.5 ± 0.1	BOTTOM DIMENSION
D0	$1.5^{+0.1}_0$	
E	1.5 ± 0.1	
F	5.65 ± 0.1	
P0	4.0 ± 0.1	
P1	8.0 ± 0.1	
P2	2.0 ± 0.05	
T	0.3 ± 0.05	
T2	2.0	
W	12.0 ± 0.3	
W1	9.5	THICKNESS 0.1MAX

REEL DIMENSIONS

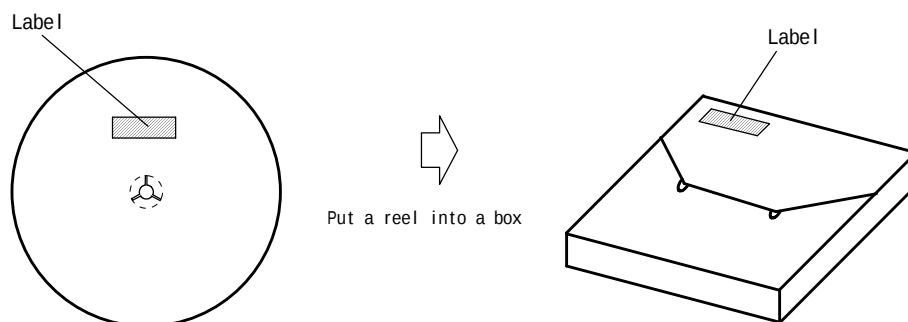


SYMBOL	DIMENSION
A	$\phi 180 \pm 1$
B	$\phi 60 \pm 1$
C	$\phi 13 \pm 0.2$
D	$\phi 21 \pm 0.8$
E	2 ± 0.5
W	13 ± 0.5
W1	1.2 ± 0.2

TAPING STATE

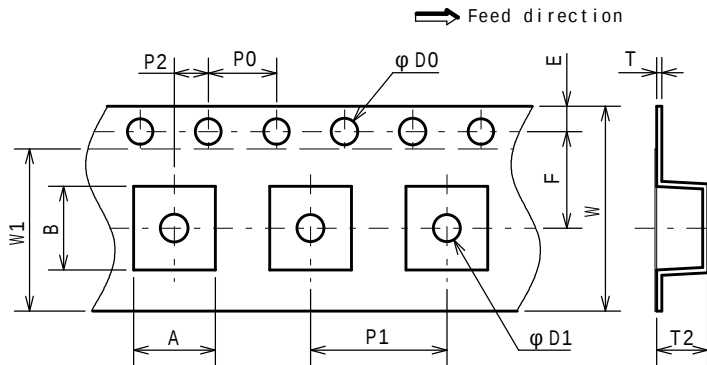


PACKING STATE



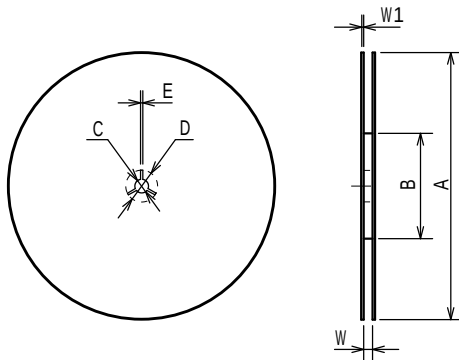
PACKING SPEC

TAPING DIMENSIONS



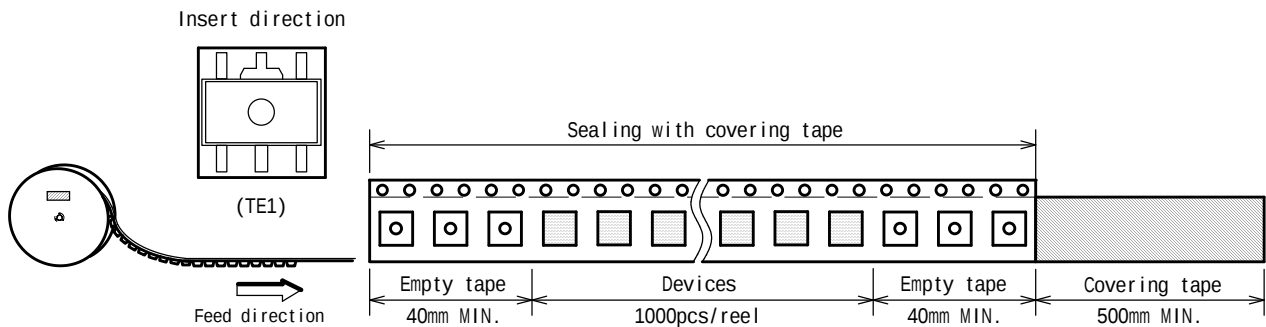
SYMBOL	DIMENSION	REMARKS
A	4.8 ± 0.1	BOTTOM DIMENSION
B	4.9 ± 0.1	BOTTOM DIMENSION
D0	$1.5^{+0.1}_0$	
D1	1.6	
E	1.5 ± 0.1	
F	5.65 ± 0.1	
P0	4.0 ± 0.1	
P1	8.0 ± 0.1	
P2	2.0 ± 0.1	
T	0.30 ± 0.05	
T2	2.0 ± 0.1	
W	12.0 ± 0.3	
W1	9.5	THICKNESS 0.1MAX

REEL DIMENSIONS

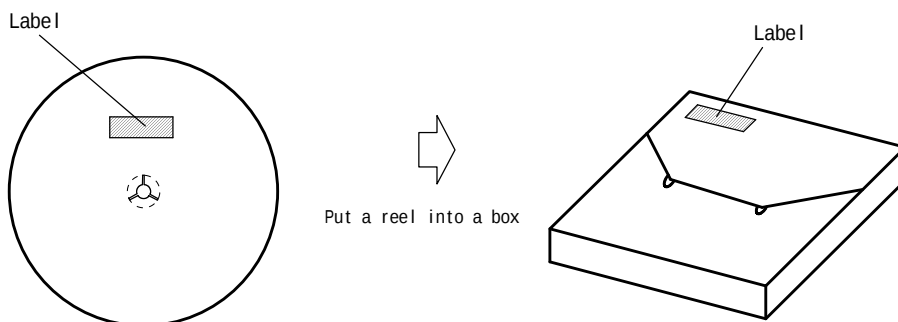


SYMBOL	DIMENSION
A	$\phi 180 \pm 1$
B	$\phi 60 \pm 1$
C	$\phi 13 \pm 0.2$
D	$\phi 21 \pm 0.8$
E	2 ± 0.5
W	13 ± 0.5
W1	1.2 ± 0.2

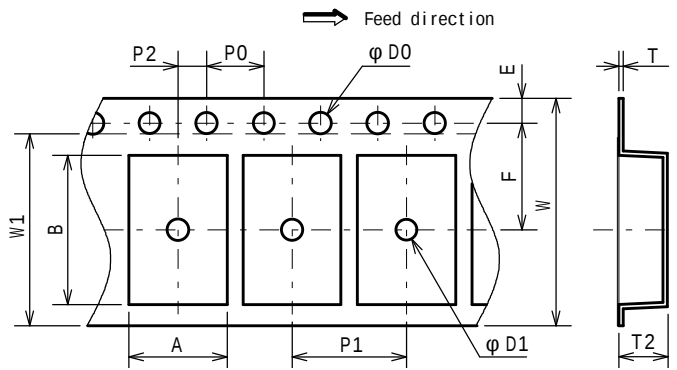
TAPING STATE



PACKING STATE

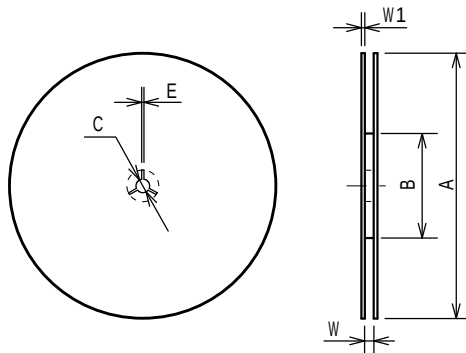


PACKING SPEC TAPING DIMENSIONS



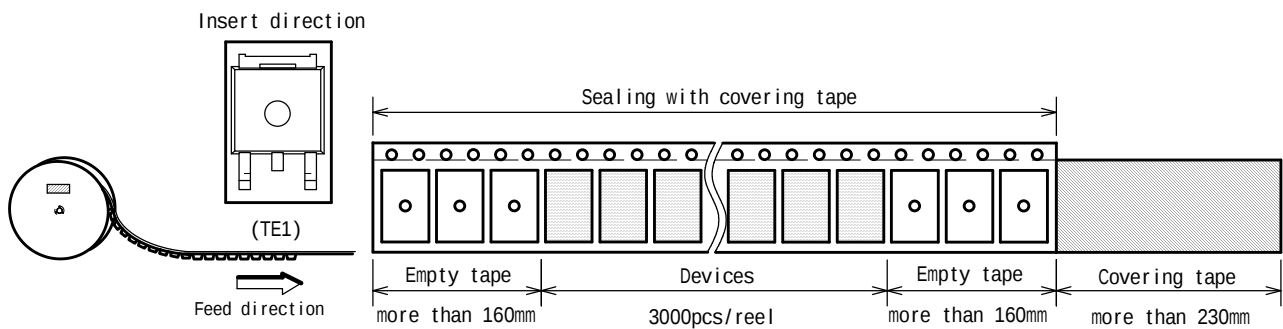
SYMBOL	DIMENSION	REMARKS
A	6.9 ± 0.1	BOTTOM DIMENSION
B	10.5 ± 0.1	BOTTOM DIMENSION
D0	$1.5^{+0.1}_0$	
D1	$1.5^{+0.1}_0$	
E	1.75 ± 0.1	
F	7.5 ± 0.05	
P0	4.0 ± 0.1	
P1	8.0 ± 0.1	
P2	2.0 ± 0.05	
T	0.3 ± 0.05	
T2	3.4 max	
W	16.0 ± 0.3	
W1	13.5	THICKNESS 0.1max

REEL DIMENSIONS

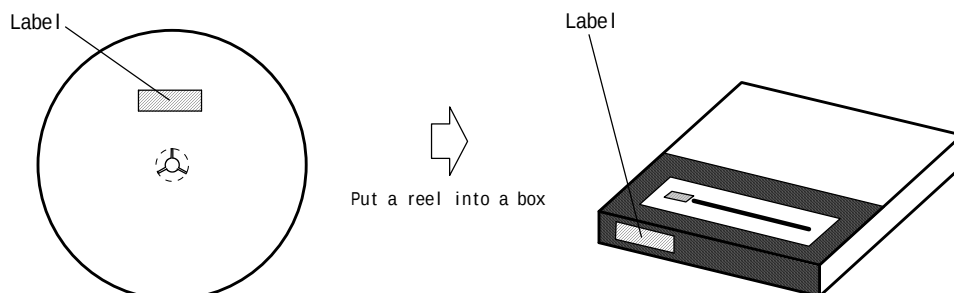


SYMBOL	DIMENSION
A	$\phi 330 \pm 2$
B	$\phi 80 \pm 1$
C	$\phi 13 \pm 0.5$
E	2
W	17.5 ± 0.5
W1	2 ± 0.5

TAPING STATE

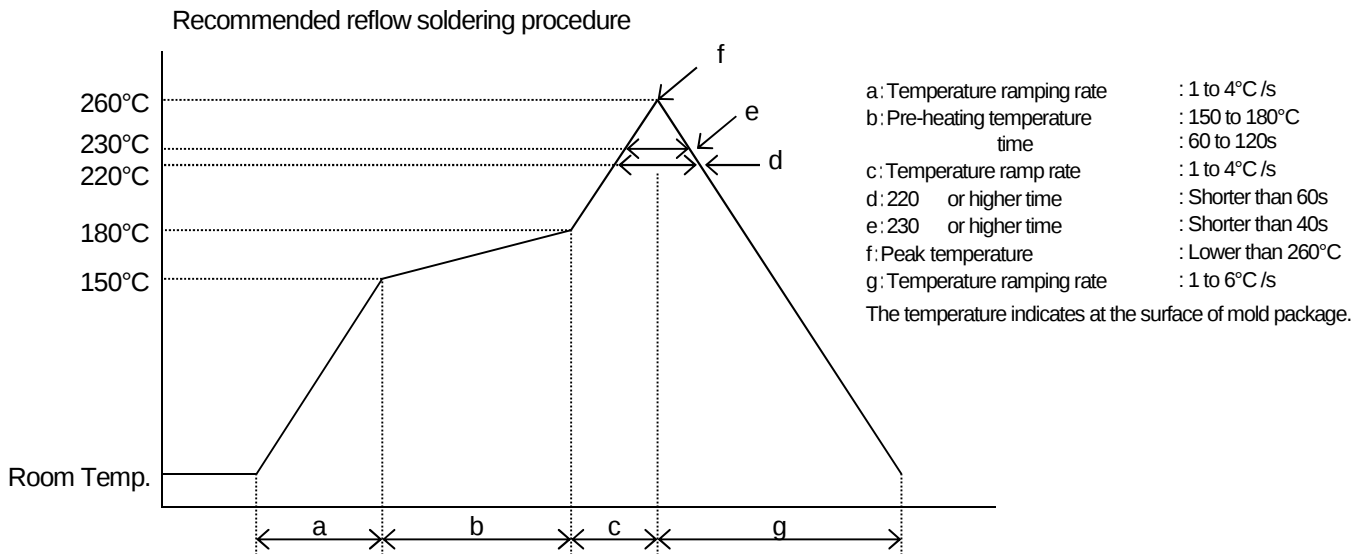


PACKING STATE

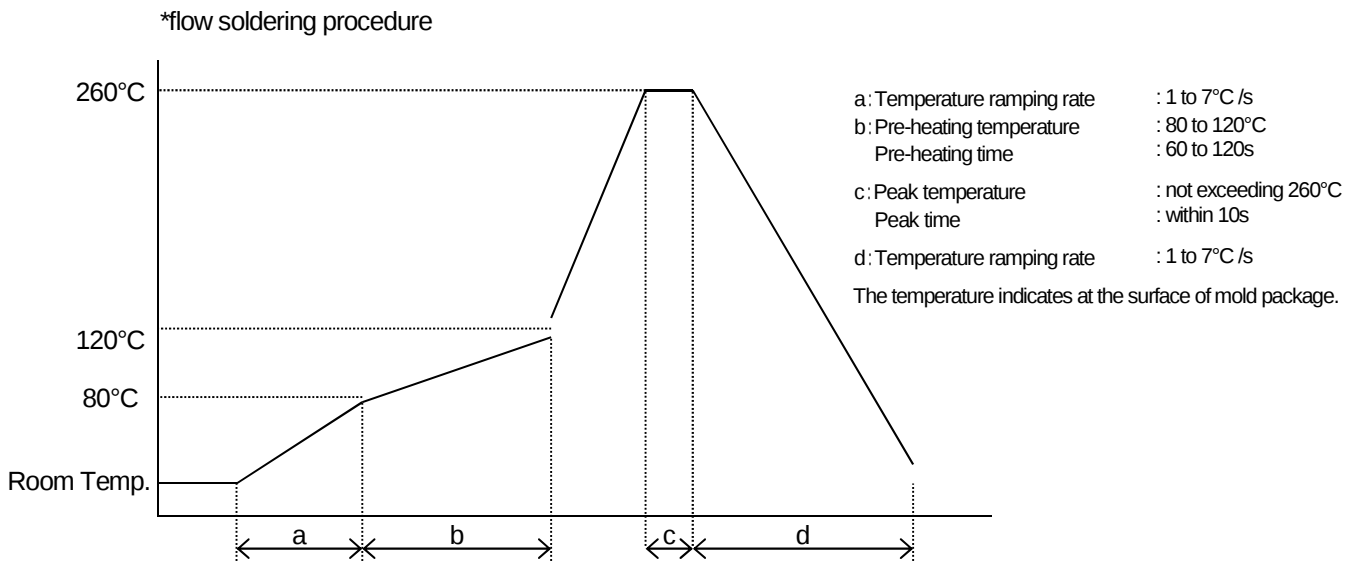


■RECOMMENDED MOUNTING METHOD

INFRARED REFLOW SOLDERING METHOD



INFRARED FLOW SOLDERING METHOD



■REVISION HISTORY

Date	Revision	Changes
04.Apr.2017.	Ver.1.0	New Release
27.Aug.2018	Ver.1.1	Correction of erroneous description

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